





BZT52B2V4 - BZT52B43 ZENER DIODES



Features

- Planar Die Construction
- 350mW Power Dissipation on Ceramic PCB
- General Purpose, Medium Current
- Ideally Suited for Automated Assembly Processes
- Available in Lead Free Version
- This is a Halogen Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: SOD-123, Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202,
- Method 208
- Polarity: Cathode Band
- Weight: 0.01 grams(approx)

Maximum Ratings @T_A=25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Forward Voltage (Note 2) @I _F =10mA	V _F	0.9	V
Power Dissipation(Note 1)	P _D	350	mW
Thermal resistance junction to Ambient	R _{θJA}	357	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C







Electrical Characteristics @T_A=25°C unless otherwise specified

Type Number	Type Code	Zener Voltage Range (Note 2)		Maximum Zener Impedance (Note 3)		Maximum Reverse Current		Typical Temperature Coefficent @Izrc		Test Current I _{ZTC}			
			V z @I zt	I	I _{ZT}	Z _{ZT} @I _{ZT}	Z _{ZK} @I _{ZK}	I _{ZK}	I _R V _R		mV/°C		
		Nom(V)	Min(V)	Max(V)	mA	Ω	8	mA	μA	V	Min	Max	mA
BZT52B2V4	2WX	2.4	2.35	2.45	5	100	600	1.0	50	1.0	-3.5	0	5
BZT52B2V7	2W1	2.7	2.65	2.75	5	100	600	1.0	20	1.0	-3.5	0	5
BZT52B3V0	2W2	3.0	2.94	3.06	5	95	600	1.0	10	1.0	-3.5	0	5
BZT52B3V3	2W3	3.3	3.23	3.37	5	95	600	1.0	5	1.0	-3.5	0	5
BZT52B3V6	2W4	3.6	3.53	3.67	5	90	600	1.0	5	1.0	-3.5	0	5
BZT52B3V9	2W5	3.9	3.82	3.98	5	90	600	1.0	3	1.0	-3.5	0	5
BZT52B4V3	2W6	4.3	4.21	4.39	5	90	600	1.0	3	1.0	-3.5	0	5
BZT52B4V7	2W7	4.7	4.61	4.79	5	80	500	1.0	3	2.0	-3.5	0.2	5
BZT52B5V1	2W8	5.1	5.00	5.20	5	60	480	1.0	2	2.0	-2.7	1.2	5
BZT52B5V6	2W9	5.6	5.49	5.71	5	40	400	1.0	1	2.0	-2.0	2.5	5
BZT52B6V2	2WA	6.2	6.08	6.32	5	10	150	1.0	3	4.0	0.4	3.7	5
BZT52B6V8	2WB	6.8	6.66	6.94	5	15	80	1.0	2	4.0	1.2	4.5	5
BZT52B7V5	2WC	7.5	7.35	7.65	5	15	80	1.0	1	5.0	2.5	5.3	5
BZT52B8V2	2WD	8.2	8.04	8.36	5	15	80	1.0	0.7	5.0	3.2	6.2	5
BZT52B9V1	2WE	9.1	8.92	9.28	5	15	100	1.0	0.5	6.0	3.8	7.0	5
BZT52B10	2WF	10	9.80	10.20	5	20	150	1.0	0.2	7.0	4.5	8.0	5
BZT52B11	2WG	11	10.78	11.22	5	20	150	1.0	0.1	8.0	5.4	9.0	5
BZT52B12	2WH	12	11.76	12.24	5	25	150	1.0	0.1	8.0	6.0	10.0	5
BZT52B13	2WI	13	12.74	13.26	5	30	170	1.0	0.1	8.0	7.0	11.0	5
BZT52B15	2WJ	15	14.70	15.30	5	30	200	1.0	0.1	10.5	9.2	13.0	5
BZT52B16	2WK	16	15.68	16.32	5	40	200	1.0	0.1	11.2	10.4	14.0	5
BZT52B18	2WL	18	17.64	18.36	5	45	225	1.0	0.1	12.6	12.4	16.0	5
BZT52B20	2WM	20	19.60	20.40	5	55	225	1.0	0.1	14.0	14.4	18.0	5
BZT52B22	2WN	22	21.56	22.44	5	55	250	1.0	0.1	15.4	16.4	20.0	5
BZT52B24	2WO	24	23.52	24.48	5	70	250	1.0	0.1	16.8	18.4	22.0	5
BZT52B27	2WP	27	26.46	27.54	2	80	300	0.5	0.1	18.9	21.4	25.3	2
BZT52B30	2WQ	30	29.40	30.60	2	80	300	0.5	0.1	21.0	24.4	29.4	2
BZT52B33	2WR	33	32.34	33.66	2	80	325	0.5	0.1	23.1	27.4	33.4	2
BZT52B36	2WS	36	35.28	36.72	2	90	350	0.5	0.1	25.2	30.4	37.4	2
BZT52B39	2WT	39	38.22	39.78	2	130	350	0.5	0.1	27.3	33.4	41.2	2
BZT52B43	2WU	43	41.16	42.84	2	130	350	0.5	0.1	29.4	36.4	45.2	2

Notes: 1. Device mounted on ceramic PCB: 7.6mm x 9.4mm x 0.87mm with pad areas 25mm²

3. f = 1kHz

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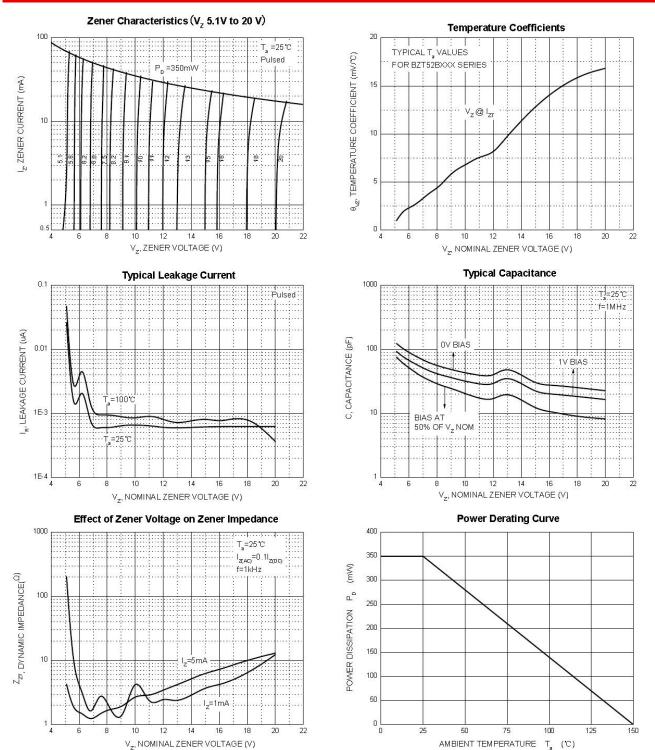
^{2.} Short duration test pulse used to minimize self-heating effect

[•] China - Germany - Korea - Singapore - United States •





Ratings and Characteristics Curves



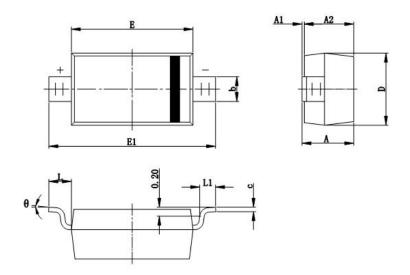
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Mechanical Dimensions SOD-123



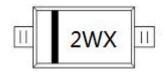
0)44501	Millin	neters	Inches			
SYMBOL	MIN.	MAX.	MIN.	MAX.		
Α	1.050	1.250	0.041	0.049		
A1	0.000	0.100	0.000	0.004		
A2	1.050	1.150	0.041	0.045		
b	0.450	0.650	0.018	0.026		
С	0.080	0.150	0.003	0.006		
D	1.500	1.700	0.059	0.067		
E	2.600	2.800	0.102	0.110		
E1	3.550	3.850	0.140	0.152		
L	0.500	REF.	0.020 REF.			
L1	0.250	0.450	0.010	0.018		
θ	0°	8°	0°	8°		

Ordering Information

Device	Package	Shipping
BZT52B2V4 - BZT52B43	SOD-123	3000pcs / reel
BZT52B2V4TR - BZT52B43TR	SOD-123	3000pcs / reel

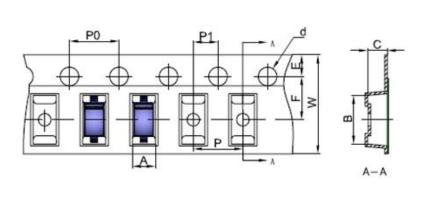
For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



2WX = Type code

Carrier Tape Specification SOD-123



SYMBOL	Millimeters				
STWIBOL	Min.	Max.			
Α	1.80	1.90			
В	3.89	3.99			
C	1.52	1.62			
d	1.45	1.65			
E	1.65	1.85			
F	3.40	3.60			
Р	3.90	4.10			
P0	3.90	4.10			
P1	1.90	2.10			
W	7.90	8.30			

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